

## R 2 4 200 NETHE UNITED STATES PATENT AND TRADEMARK OFFICE

Brian Labrec

Application No.: 10/677,092

Filed: September 30, 2003

For:

INCREASING THERMAL CONDUCTIVITY

OF HOST POLYMER USED WITH LASER

**ENGRAVING METHODS AND** 

**COMPOSITIONS** 

Examiner: S. McClendon

Date: April 19, 2006

Art Unit 1711

Confirmation No. 4087

**CERTIFICATE OF MAILING** 

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service on April 19, 2006 as First Class Mail in an envelope addressed to: MAIL STOP RCE, COMMISSIONER FOR PATENTS, P.O. Box 1450, Alexandria, VA

22313-1450.

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## INFORMATION DISCLOSURE STATEMENT

MAIL STOP RCE COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

Applicants submit herewith information of which they are aware, and which they believe may be material to the examination of the application and in respect of which there may be a duty to disclose in accordance with 37 C.F.R. § 1.56. The information is listed on the attached Form PTO-1449 and copies of the foreign patent documents are enclosed.

The submission of information on the attached Form PTO-1449 is not intended as an admission that any such information constitutes prior art against the claims of the application under examination. Applicants do not waive any right to take any appropriate action to antedate or otherwise remove any information from the attached Form PTO-1449.

No fee is required since this document is being submitted with a Request for Continued Examination.

If a fee is required, please charge to Deposit Account No. 50-2535 any fees that may be required for considering this Information Disclosure Statement under 37 C.F.R. § 1.17(p).

Date: April 19, 2006

Respectfully submitted,

DIGIMARC CORPORATION

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INFORMATION

4. DISCLOSURE

STATEMENT

Docket: P0889D Ser. No.: 10/677,092

Applicant: Brian Labrec

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Number 3,153,166 5,639,819	Date	Inventor	Class
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Number	Foreign Patent I	Documents  Country	Class
EP0697433	2/21/96	EP	1
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Examiner Signature:	Date Considered:

<sup>\*</sup>Examiner: Initial if considered, whether or not in conformance with MPEP 609; draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.